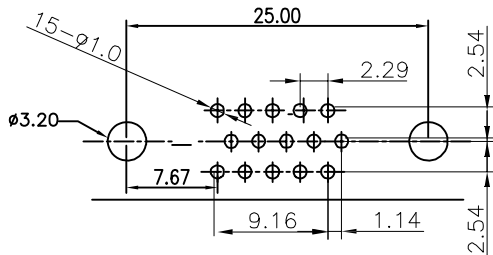
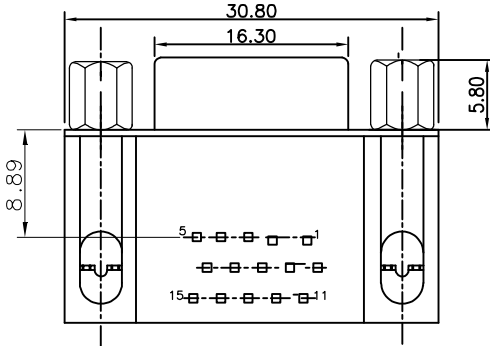
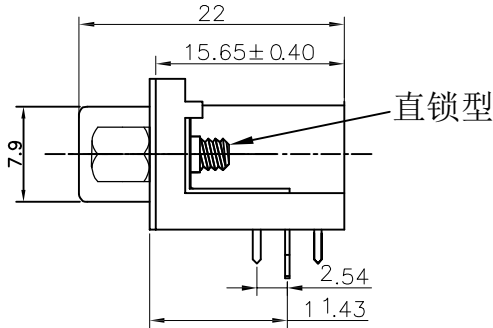
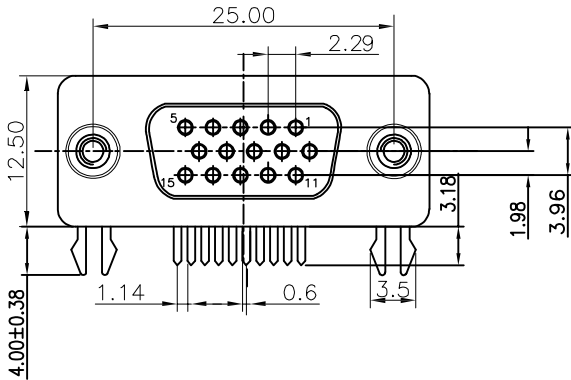


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS



PCB Holes Diagram(Top View)

NOTE:

1.MATERIAL:

- 1.1 HOUSING:PBT,
- 1.2 TERMINAL:COPPER ALLOY.
- 1.3 SHELL:SPCC
- 1.4 HARPOON:SPCC
- 1.5 SCREW:SPCC

2. PLATING:

- 2.1 CONTACT: 80u" Min.MATTE TIN NICKEL PLATED OVERALL 50u" Min. NICKEL UNDER-PLATED
- 2.2 SHELL:50u" Min, NICKEL PLATED OVERALL
- 2.3 HARPOON:50u" Min, TIN PLATED OVERALL.
- 2.4 SCREW:50u" Min, NICKEL PLATED OVERALL.

3. SPECIFICATIONS:

VOLTAGE: 250 VAC(RMS) MAX.
CURRENT RATING: 3 AMPERE PER CONTACT
CONTACT RESISTANCE: 25 MILLIOHMS MAX.
INSULATION RESISTANCE: 1000 MEGOHMS MIN.
DIELECTRIC WITHSTANDING VOLTAGE: 500V AC(RMS)
MATING FORCE: 5.1Kg.Max.
UNMATING FORCE: 1.0Kg.MIN
OPERATING TEMPERATURE:-25? ~ +85?

P/N:WLDBF9-15 1 X X 0 145

PLATING: 1-G/F COLOUR: E-YELLOW

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLDBF9-151XX0145	DWG.NO: ENDE05	 WanLian Teconology Co., Ltd	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13				
				0.0±0.35	X°REF±6°	DESIGNER	Han_Gao	21.01.13	TITLE: HDR8.89 15F 90°DIP Direct Lock XL Harpoon		REV: A0	SHEET: 1/1
				UNIT:mm	0.00±0.25	X°±3°						
				SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	Zijun_Huang				